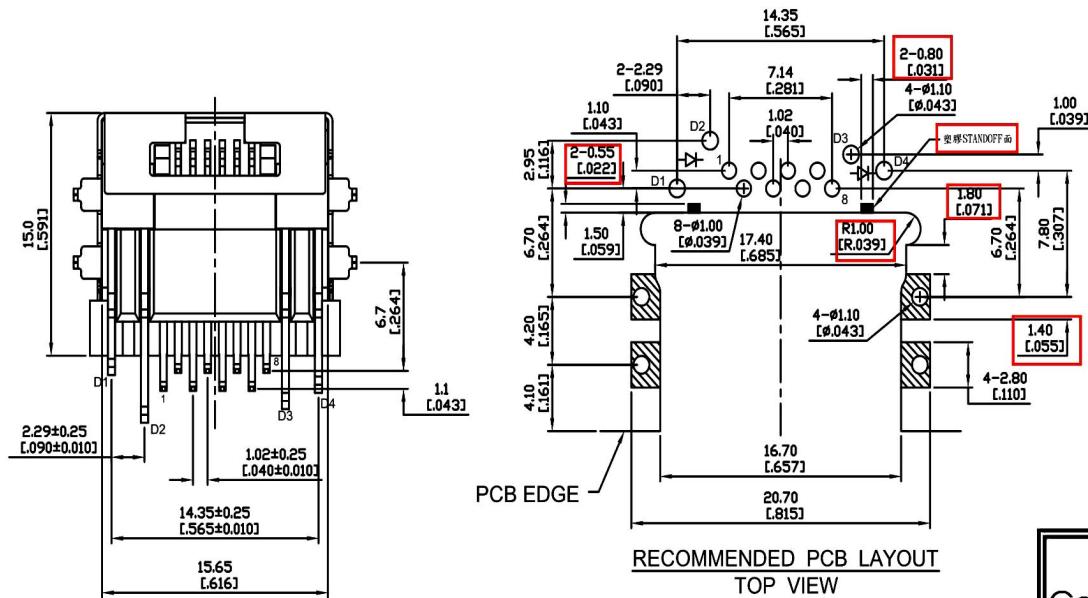


Electrical Characteristics :
 Insulation Resistance : 500MΩ Min.
 Contact Resistance : 50mΩ Max.
 Withstand Voltage : 500 VAC 1 minute.
 Current Rating : 1.5A

Material:
 Housing: Thermoplastic UL 94V-0
 Contact : Selective Gold Plating
 Terminal: 0.25mm Thickness Copper Alloy
 Plated With Gold And Tin In Solder Area.
 Shell: Alloy, Nickel Plating
 Fork: Alloy



RECOMMENDED PCB LAYOUT
 TOP VIEW
 TOLERANCE: ±0.05mm
 PCB THICKNESS: 1.20±0.05mm

RoHS Compliant		HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准	SCALE 比例 参考	TOLERANCE(公差): 0.000 mm ± 0.075 mm 0.00 mm ± 0.15 mm 0.0 mm ± 0.25 mm	PART NAME 品名 SIDE ENTRY PCB JACK OFFSET TYPE 8P8C DIP TYPE WITH SHIELDED WITH LED (LEFT:YELLOW/RIGHT:GREEN) BLACK COLOR ROHS
DWG. 製圖 Betty	UNIT 單位 MM	SIZE: 紙張尺寸 A4	PART NO. 料號 C0098-88YXB100R
DATE 制表日 2015/06/08	PAGE 張數 1 OF 1	REV. 版次 C	